

SIMATIC IPC547J (rack PC, 19", 4 U); interfaces: 2x USB 3.0 on the front; COM1, audio on the rear side; 7 slots: 5x PCI Express, 2x PCI, temperature and fan monitoring; watchdog; card retainer Core i7-10700E (8C/16T, 2.9 (4.5) GHz, 16 MB cache); mainboard (chipset H410, 2x Gbit Ethernet, 1x DVI-D, 1x DisplayPort, 4x USB 2.0, 2x USB 3.1 Gen. 1, 1x USB 2.0 internal); 1 TB HDD 3.5 SATA, enclosure (short) with drive support type C (for internal installation/ 0.2 g vibration, 2 g shock), blue chromated, 100/240 V AC industrial power supply unit, power supply cable China, 32 GB DDR4 SDRAM (2x 16 GB), dual channel, without expansion, without operating system, without expansions,

General information	
Product type designation	IPC547J
Installation type/mounting	
Mounting	For horizontal and vertical installation; prepared for telescopic rails; 19" mounting bracket can be removed externally; tower kit (optional)
Design	Rack PC, 19", 4U
Supply voltage	
Type of supply voltage	100/240 V AC (autorange) 50 / 60 Hz; optional redundant 100/240 V AC
Line frequency	
• Rated value 50 Hz	Yes
• Rated value 60 Hz	Yes
Mains buffering	
• Mains/voltage failure stored energy time	20 ms
Processor	
Processor type	Intel Xeon W-1270E (8C/16T, 3.4 (4.8) GHz, 16 MB Cache); Intel Core i9-10900E (10C/20T, 2.8 (4.7) GHz, 20 MB Cache); Intel Core i7-10700E (8C/16T, 2.9 (4.5) GHz, 16 MB Cache); Intel Core i5-10500E (6C/12T, 3.1 (4.2) GHz, 12 MB Cache); Intel Core i3-10100E (4C/8T, 3.2 (3.8) GHz, 6 MB Cache)
Chipset	Intel W480E / Intel H410
Graphic	
Graphics controller	Intel® UHD Graphics 630
Drives	
Hard disk	1 TB HDD 3.5" SATA, 2x 1 TB HDD 3.5" SATA, 1 TB HDD 3.5" SATA + 960 GB SSD 2.5" SATA, RAID1, 2x 1 TB HDD 3.5" SATA, RAID1, 2x 1 TB HDD [Enterprise] 3.5" SATA, RAID1, 2x 2 TB HDD [Enterprise] 3.5" SATA, RAID1, 2x 2 TB HDD [Enterprise] 3.5" SATA + 2 TB HDD [Enterprise] 3.5" SATA as hot spare, RAID1, 2x 2 TB HDD [Enterprise] 3.5" SATA + 960 GB SSD 2.5" SATA, RAID5, 3x 2 TB HDD [Enterprise] 3.5" SATA, RAID5, 3x 2 TB HDD [Enterprise] 3.5" SATA + 2 TB HDD [Enterprise] 3.5" SATA as hot spare
SSD	Yes; 480 GB 2.5" SATA SSD, 1x 960 GB 2.5" SATA SSD, 2x 480 GB 2.5" SATA SSD, RAID1 2x 480 GB 2.5" SATA SSD, RAID1 2x 960 GB 2.5" SATA SSD; 1x 512 GB M.2 NVMe SSD, 1x 1 024 GB M.2 NVMe SSD
Slot for drives	Mounting internally in vibration/shock-absorbing drive cage Type B or mounting on the front in removable trays (hot swap in RAID configurations) in drive cage Type A; mounting internally on the fixed drive cage optional
Memory	
Main memory	4 GB to 128 GB DDR4 2933 SDRAM DIMM
Capacity of main memory, max.	128 Gbyte
Hardware configuration	
Slots	
• free slots	7 spare slots for expansions (all long); mainboard with H410 chip set: 1x PCIe (x16) (16 lane) Gen 3, 1x PCIe (x16) (1 lanes) Gen 3, 1x PCIe (x8) (1 lane) Gen 3, 1x PCIe (x4) (1 lane) Gen 3, 1x PCIe (x4) (1 lane) Gen 3, 2x PCI; mainboard with W480E chip set: 1x PCIe (x16) (16 lane) Gen 3, 1x PCIe (x16) (4 lanes) Gen 3, 1x PCIe (x8) (1 lane) Gen 3, 1x PCIe

(x4) (4 lane) Gen 3, 1x PCIe (x4) (1 lane) Gen 3, 2x PCI

Interfaces

Interfaces/bus type	mainboard (H410 chip set): 2x Intel Gigabit Ethernet (RJ45, teaming-capable), USB 3.1 Gen 1: 2x on rear, 2x on front, USB 2.0: 4x on rear, 1x internal e.g. for software dongle with optional interlock, 1x DisplayPort V1.2, 1x DVI-D, 1x COM1, audio: line in, line out, micro; mainboard (W480E chip set): 3x Intel Gigabit Ethernet (RJ45, teaming-capable), USB 3.1 Gen 2: 4x type A, 2x type C, on rear, USB 3.1 Gen 1: 2x on front, USB 2.0: 2x internal e.g. for software dongle with optional interlock, 2x DisplayPort V1.2, 1x DVI-D, 1x COM1, audio: line in, line out, micro
USB port	mainboard (H410 chip set): USB 3.1 Gen 1: 2x on rear, 2x on front, USB 2.0: 4x on rear, 1x internal e.g. for software dongle with optional interlock; mainboard (W480E chip set): USB 3.1 Gen 2: 4x type A, 2x type C, on rear, USB 3.1 Gen 1: 2x on front, USB 2.0: 2x internal e.g. for software dongle with optional interlock
Connection for keyboard/mouse serial interface	USB COM1: 1x RS 232 or RS 485; COM2 (optional) 1x RS 232
Multimedia	
• Audio In/Out	Yes
• Microphone In	Yes
Video interfaces	
• Graphics interface	2x DisplayPort and 1x DVI-D onboard; 1x VGA via DP-VGA adapter cable (optional); graphics card PCIe (x16), Triple Head (3x mini DisplayPort, 2 GB graphics memory, 3x mini DisplayPort to DisplayPort adapter cable) (optional)
Industrial Ethernet	
• Industrial Ethernet interface	2x or 3x Gigabit Ethernet (IE/PN), RJ45
— 100 Mbps	Yes
— 1000 Mbps	Yes
Integrated Functions	
Monitoring functions	
• Temperature monitoring	Yes
• Watchdog	Yes
• Status LEDs	POWER, HDD, ETHERNET 1, ETHERNET 2, ETHERNET 3, WATCHDOG, TEMP, FAN, HDD3 ALARM, HDD2 ALARM, HDD1 ALARM, HDD0 ALARM
• Fan	Yes
• Monitoring function via network	Optional
EMC	
Interference immunity against discharge of static electricity	
• Interference immunity against discharge of static electricity	±4 kV contact discharge acc. to IEC 61000-4-2; ±8 kV air discharge acc. to IEC 61000-4-2
Interference immunity against high-frequency electromagnetic fields	
• Interference immunity against high frequency radiation	10 V/m for 80 ... 2 700 MHz, 80% AM acc. to IEC 61000-4-3; 3 V/m for 2.7 to 6 GHz, 80% AM acc. to IEC 61000-4-3; 10 V for 10 kHz to 80 MHz, 80% AM acc. to IEC 61000-4-6
Interference immunity to cable-borne interference	
• Interference immunity on supply cables	±2 kV acc. to IEC 61000-4-4, burst; ±1 kV acc. to IEC 61000-4-5, surge symmetric; ±2 kV acc. to IEC 61000-4-5, surge asymmetric
• Interference immunity on signal cables >30m	±2 kV acc. to IEC 61000-4-5, surge, length > 30 m
• Interference immunity on signal cables < 30m	±1 kV acc. to IEC 61000-4-4, Burst
Interference immunity against voltage surge	
• asymmetric interference	±2 kV acc. to IEC 61000-4-5, surge asymmetric
• symmetric interference	±1 kV acc. to IEC 61000-4-5, surge symmetric
Interference immunity to magnetic fields	
• Interference immunity to magnetic fields at 50 Hz	30 A/m; to IEC 61000-4-8
Emission of conducted and non-conducted interference	
• Interference emission via line/AC current cables	EN 61000-6-3; EN 61000-6-4, CAN/CSA CISPR 22 Class B, EN 55032 Class B; FCC Class A; KN32 Class B, EN 61000-3-2 Class D; EN 61000-3-3
Compliance with line harmonic distortion limits	
• Compliance with line harmonic distortion acc. to IEC 61000-3-2, IEC 61000-3-3	Yes; EN 61000-3-2 Class D; EN 61000-3-3
Degree and class of protection	
IP (at the front)	IP30
IP (rear)	IP20

Standards, approvals, certificates	
CE mark	Yes; For use in industrial areas as well as domestic, business and commercial environments (emitted interference: EN 61000-6-3:2007 +A1:2011, noise immunity: EN 61000-6-2:2005)
CSA approval	Yes; CAN/CSA-C22.2 No. 61010-2-201 Second Edition
UL approval	UL 61010-2-201 Second Edition, File E85972
cULus	Yes; UL 61010-2-201 Second Edition; CAN/CSA-C22.2 No. 61010-2-201 Second Edition
RCM (formerly C-TICK)	Yes
KC approval	Yes
EAC (formerly Gost-R)	Yes
EMC	EN 61000-6-3; EN 61000-6-4, CAN/CSA CISPR 22 Class B, EN 55032 Class B; FCC Class A; KN32 Class B, EN 61000-3-2 Class D; EN 61000-3-3
Dust protection	With front door closed: G2 EN 779, 99% of particles > 0.5 mm are filtered
Ambient conditions	
Ambient temperature during operation	
• Ambient temperature during operation	0 °C to +40 °C with full configuration
Ambient temperature during storage/transportation	
• min.	-20 °C
• max.	60 °C
Relative humidity	
• Relative humidity	Tested according to IEC 60068-2-78, IEC 60068-2-30: Operation: 5 % to 85 % at 30 °C (no condensation), storage / transport: 5 % to 95 % at 25 / 55 °C (no condensation)
Vibrations	
• Vibration resistance during operation acc. to IEC 60068-2-6	Tested according to IEC 60068-2-6, 10 cycles; 20 to 58 Hz: 0.015 mm; 58 to 200 Hz: 2 m/s ² (0.2 g)
Shock testing	
• Shock load during operation	Tested according to IEC 60068-2-27; half-sine: 9.8 m/s ² (1 g), 20 ms, 100 shocks per axis
Operating systems	
pre-installed operating system	Windows 10 IoT Enterprise 2019 LTSC, multi-language (64-bit); Windows Server 2019 Standard Edition incl. 5 clients, multi-language (64-bit)
Additional info on operating system	Multi-Language User Interface (MUI): 5 languages (English, German, French, Spanish, Italian)
without operating system	Yes
Software	
SIMATIC Software	Optional package with SIMATIC WinCC
Dimensions	
Width	430 mm
Height	177 mm; 4U
Depth	446 mm; Device with short enclosure: 356 mm
last modified:	10/25/2022 